

FEATURES

- USB Power Delivery (PD) sink-only power role
- Support charging of 1 to 4 cell batteries
- Support type-C 1.4 & USB PD3.0 version 1.3
- External resistor to set the target RDO
- Flexible monitoring and configuration via I²C interface

APPLICATIONS

- Power tools
- Smart speakers
- Portable electronics
- Internet of Things (IoT) devices
- Handsets
- Wireless chargers

- Industrial applications

GENERAL DESCRIPTION

The HUSB238 is a highly integrated USB Power Delivery (PD) controller as sink role. The HUSB238 is compatible with USB PD3.0 V1.3 and Type-C V1.4. And it can also support charge protocols such as Apple divider 3, BC1.2 SDP, CDP and DCP. The HUSB238 can be used in electronic devices that have legacy barrel connectors (called Barrel Connector Replacement) or USB micro-B connectors. The applications can be wireless chargers, IoT (Internet of Things) devices, drones, smart speakers, power tools, and other rechargeable devices. The HUSB238 is available in 3 mm x 3 mm DFN-10L package and 3.9mm x 4 mm SOT33-6L package.

DESIGN RESOURCES

[HUSB238](#)

APPLICATION BLOCK DIAGRAM AND EVB FIGURE

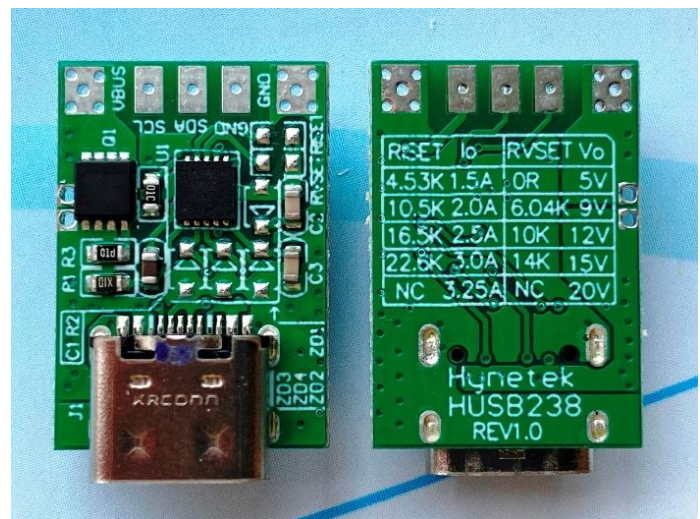
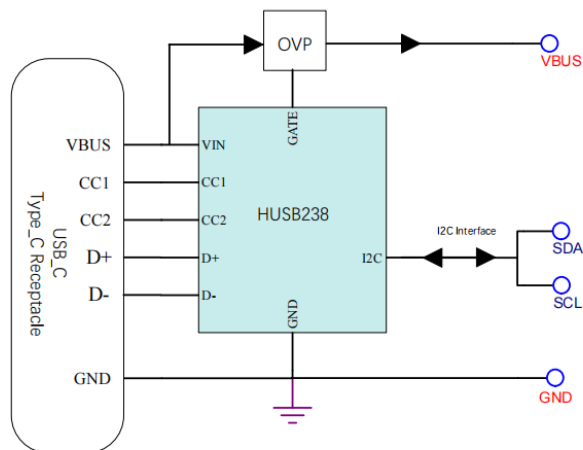


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INTRODUCTION

INTERFACE SPECIFICATIONS

There are three interfaces on this evaluation board. The following table describes the functions of each interface.

Table 1. Evaluation Board Interface Specifications

Interfaces	Descriptions
USB type-C receptacle	Connect to a standard USB PD power adaptor ($\leq 100W$) through a USB type-C cable
Power output	One Fixed PDO output of PD power adaptor (Output voltage can be set by an external resistor R_{VSET} or I ² C interface)
I ² C interface	Optional interface for advanced monitoring and programming

NOTES FOR THE EVALUATION DESIGN BOARD

The RDO of HUSB238 default factory setting is 20V3.25A. **If the USB Type-C cable does not have an eMarker chip or the eMarker indicates the cable current rating being only 3A, the maximum current rating of source capability of the PD power adaptor is only 3A and the PD power adaptor will fail to match the HUSB238. In this situation, the request current can be set to 3A (or smaller) by changing the external resistor R_{ISET} to 22k Ω (or smaller).**

Table 2. Component Selection and Function Description

Items	Specifications	Functions	Notes
Q1	Can be a single PMOS, back-to-back double PMOS or an integrated load switch	<ol style="list-style-type: none"> VBUS UVP/OVP protections Control the VOUT power-up timing and soft start time Prevention of current flowing backward 	Q1 is optional, short J2 jumper for simple design. Q1, R2 and R3 are not connected.
ZD1, ZD2, ZD3, ZD4	NC TVS SOD-323	Enhance the chip ESD capability	Optional
R_{VSET}	NC 0603 1% Resistor	Default RDO with 20V	See the recommended resistor list
R_{ISET}	NC 0603 1% Resistor	Default RDO with 3.25A	See the recommended resistor list

CIRCUIT CONNECTION

The circuit connection of HUSB238 evaluation board with the PD power adaptor and powered device is shown as Figure 1.

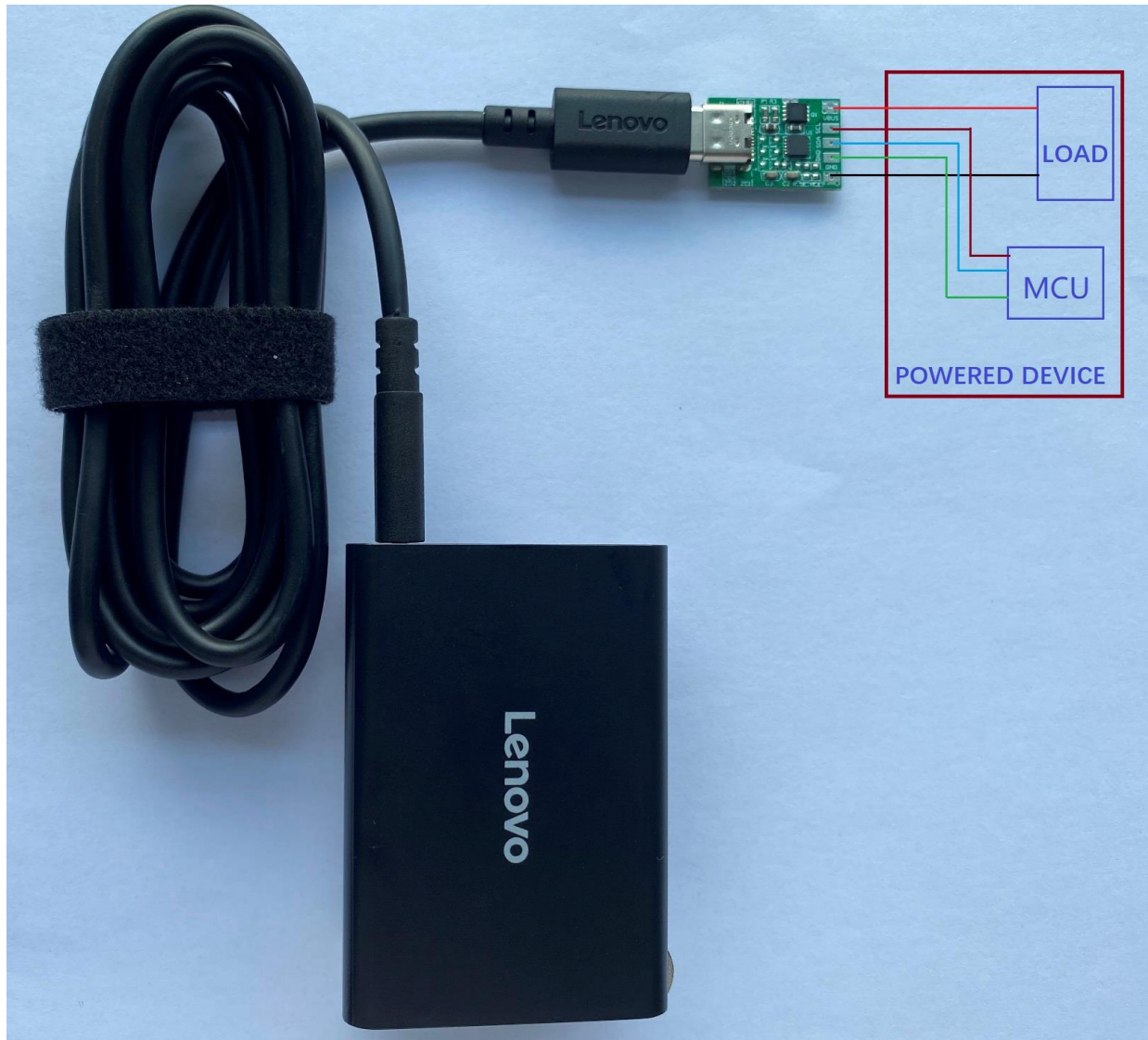


Figure 1. Circuit Connection of the EVB_HUSB238_002DD

VOLTAGE AND CURRENT REQUEST PRINCIPLE

- ◆ HUSB238 supports three kinds of voltage and current request methods:
 - Factory defaults settings (Default request voltage and current is 20V3.25A, custom design is also allowed).
 - VSET & ISET pins dynamic setting of the targeted voltage and current by changing of the R_{VSET} and/or R_{ISET} resistors connected to the VSET & ISET pins separately.
 - I²C advanced setting.
- ◆ The voltage and current of HUSB238 actually request is the lower of factory defaults setting and the VSET/ISET pins setting.
 - For example, if factory default request voltage is 20V, the VSET pin request voltage is 12V, the actual request voltage is 12V.
 - For example, if factory default request current is 2A, the ISET pin request current is 3A, and the actual request current is 2A.

- ◆ I²C advanced setting has the highest priority, it can bypass the above two kinds of settings:
 - HUSB238 stores source capability received from the USB PD power adapter. It includes all FPDOs data and other information sent from the USB PD power adapter. The MCU can choose the proper PDO according to this information.
 - **It is suggested the VEST pin be shorted to ground such that the default request voltage 5V. Then the MCU request the actual required voltage & current through the I²C interface.**
- ◆ Matching mechanism.
 - Only the voltage and current of the PD source meet the both conditions, it can be matched.
 - Request voltage value must less-than or equal-to Source PDO voltage value.
 - Request current value must less-than or equal-to Source PDO current value.
 - If the conditions are not matched, according to the HUSB238 mismatch rules, you can choose:
 - Look down for a lower voltage for matching. For example, HUSB238 requests 60W 20V3A, but the PD source provides 45W with PDOs of 5V3A, 9V3A, 12V3A, 15V3A and 20V2.25A. The 20V2.25A PDO fails to match, while the 15V3A PDO matches.
 - Request 5V PDO directly.

RECOMMEND RVSET & Riset RESISTOR VALUE LIST

The relationship of R_{VSET} value and the request voltage:

R _{VSET} (kΩ)	VSET_VOLTAGE (V)
0	5
6.04	9
10	12
14	15
17.8	18
Open	20

The relationship of R_{iset} value and the request current:

R _{iset} (kΩ)	ISET_CURERNT (A)
0	1.25
4.53	1.5
7.5	1.75
10.5	2
13.7	2.25
16.5	2.5
19.6	2.75
22.6	3
Open	3.25

The target voltage and current are dynamically applied by changing the value of R_{VSET} and R_{iset}.

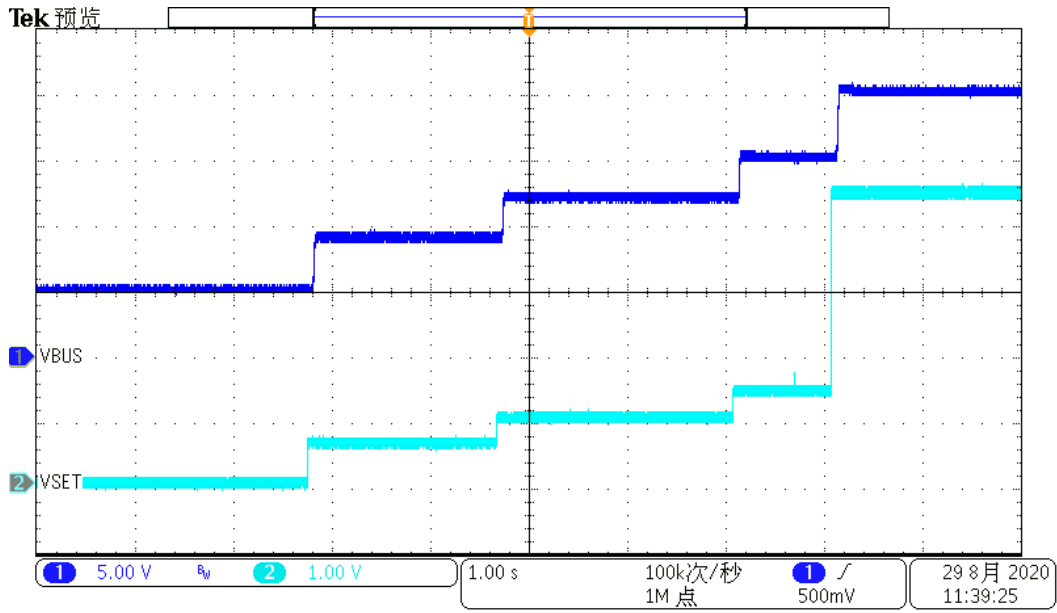


Figure 2. Dynamic Voltage Request Test Waveform

DESIGN OVERVIEW

BLOCK DIAGRAM

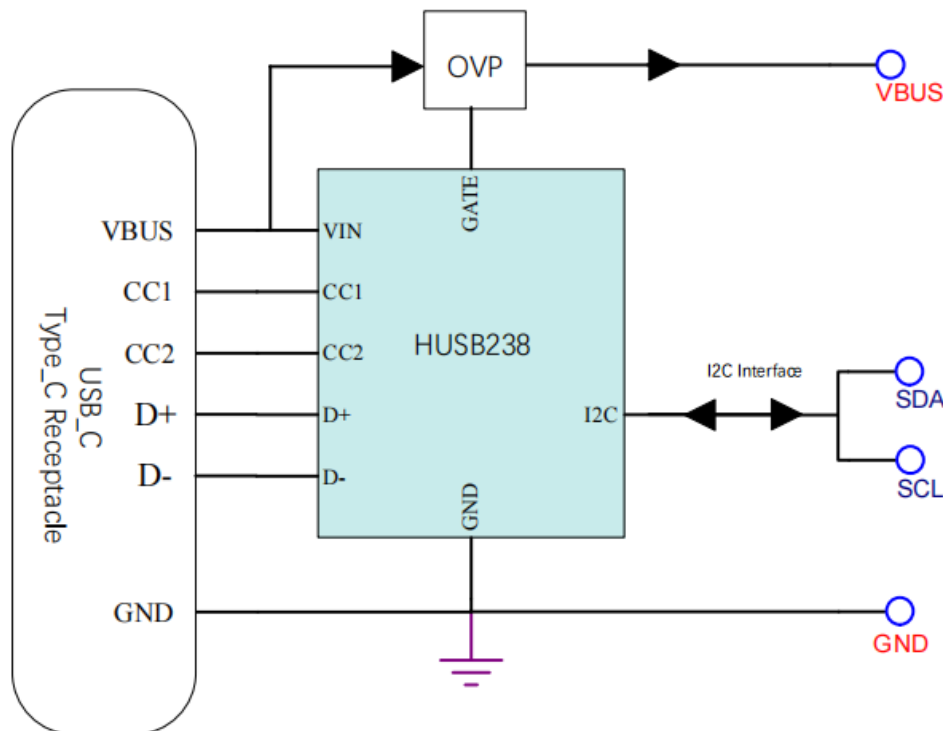


Figure 3. Block Diagram of EVB_HUSB238_002DD

KEY PRODUCTS

HUSB238 – USB PD Sink Controller

Key features of HUSB238:

- USB-IF certified PD sink controller with TID 3666
- 3mm x 3mm DFN-10L and 3.9mm x 4.0mm SOT33-6L packages options
- Support type-C 1.4 & USB PD3.0 version 1.3
- Support legacy charging sink, BC1.2 SDP, CDP & DCP detection, Apple Divider 3 detection
- 3.0V to 25V operation range
- 30V voltage rating on VBUS, GATE pins, and 25V voltage rating on CC1, CC2 pins
- External resistor to set the target RDO voltage and current
- I²C interface access for advanced PDO request
- eMarker emulator for cable application with output current > 3A
- Integrated load switch gate drivers (PMOS)
- VBUS over-voltage (OVP) and under-voltage (UVP) protection
- OTP protection, over-temperature protection with configurable thresholds
- Low power consumption
- Operating temperature -40 °C to 125 °C

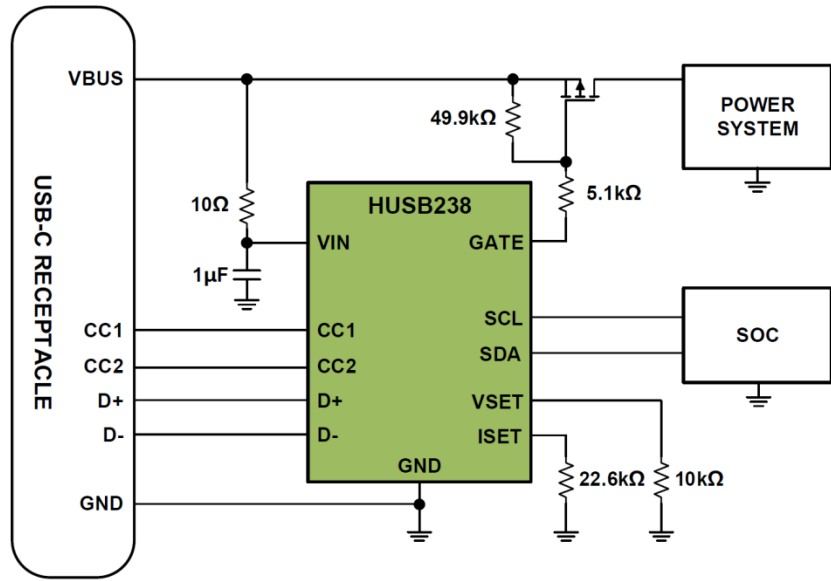


Figure 4. HUSB238 Typical Application Circuit

TEST RESULT

TEST CONDITIONS

Room temperature test condition.

Input: 65W or above USB PD power adapter.

Output: DC 5V to 20V.

TEST EQUIPMENTS

Oscilloscope Tektronix MDO3024, Lenovo 65W USB PD power adapter, multi-meter.

I²C interface monitoring requires additional equipment, including: a computer with USB interface, USB data lines, [Total Phase Aardvark I2C/SPI Host Adapter](#), and Total Phase software USB_V2.16.exe.

TEST SETTING

Figure 5. shows a Lenovo 65W USB PD power adapter connected to the HUSB238 evaluation board to output 20V. The request voltage is set by the R_{VSET} resistor



Figure 5. EVB Tested by R_{VSET} and R_{ISET} Resistors

Figure 6. shows the dynamic voltage request through I²C interface. The source capabilities information of the Lenovo 65W USB PD power adapter can be read through I²C interface.

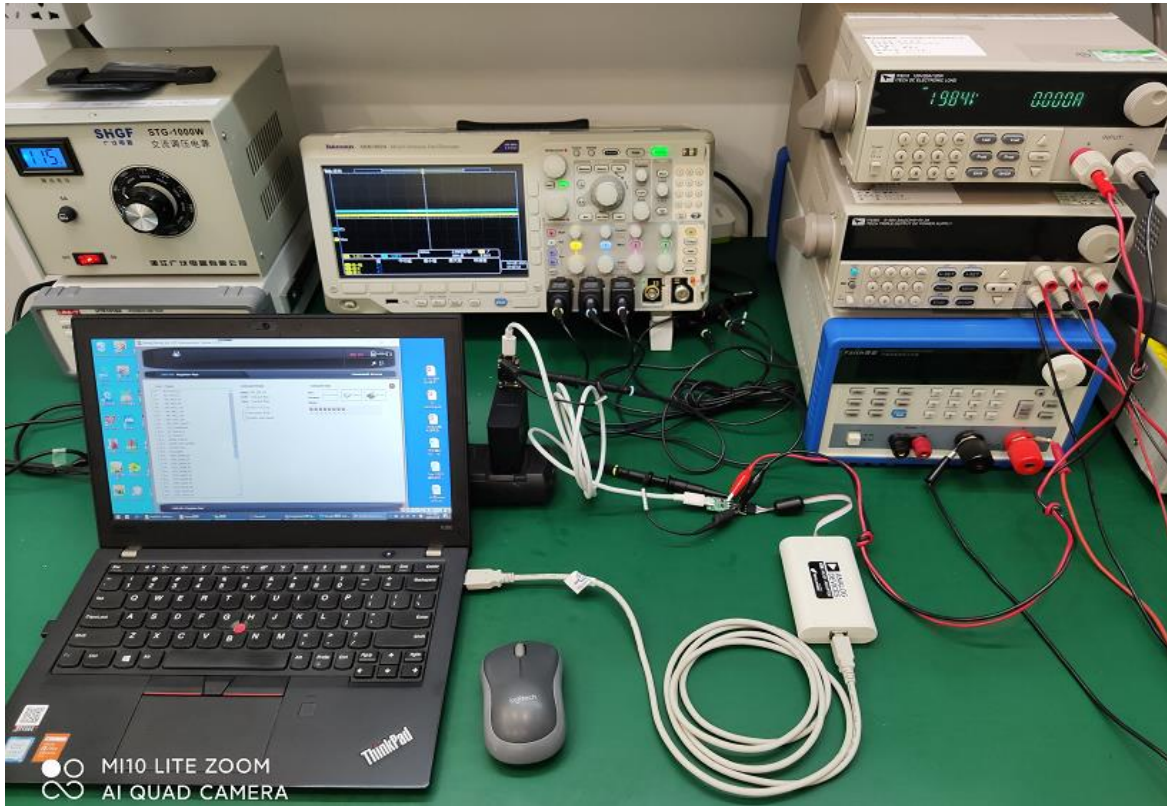


Figure 6. EVB test through I²C Interface

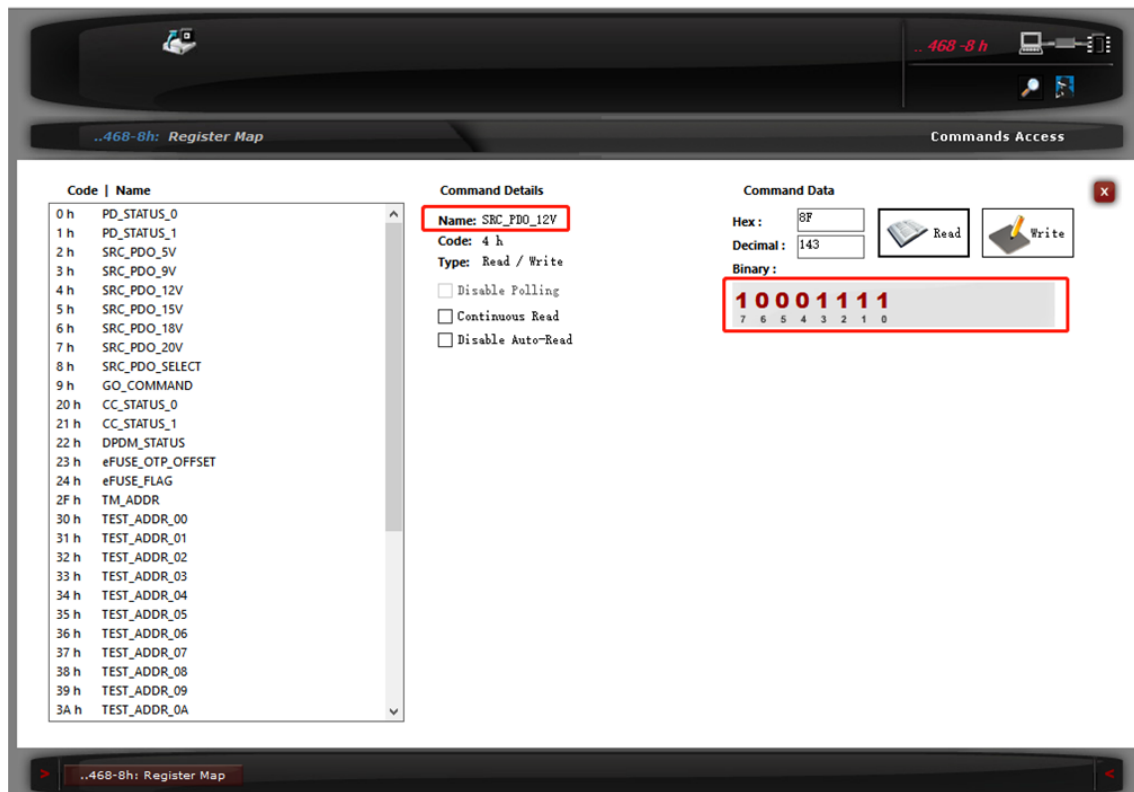


Figure 7. The Source Capabilities Information of the Lenovo 65W USB PD Power Adapter

TEST PROCESS

Test item 1, request PDO through external resistor:

1. Connect the Lenovo 65W USB PD power adapter output to EVB_HUSB238_002DD with a USBC Type-C to USB Type-C cable.
2. Power on the 65W USB PD power adapter, use a multi-meter to measure the voltage between VBUS pad and ground in the EVB_HUSB238_002DD.
3. Change the R_{VSET} resistor value in the EVB_HUSB238_002DD, check the change of the output voltage.

Test item 2, request PDO through the I²C interface:

4. Connect the computer to the Total Phase Aardvark I2C/SPI Host Adapter with the USB data cable, connect the I²C interface of the EVB_HUSB238_002DD to the Total Phase Aardvark I2C/SPI Host Adapter. And run the I²C software on the computer.
5. Select device address 0x08 to open the HUSB238 register map in the I²C software. Then select the target register address. Click on "Read" button to read the specified register value. Click on "Write" button to write a value to the specified register.
6. Capture the waveforms shown in Figure 8. and Figure 9.

TEST WAVEFORMS

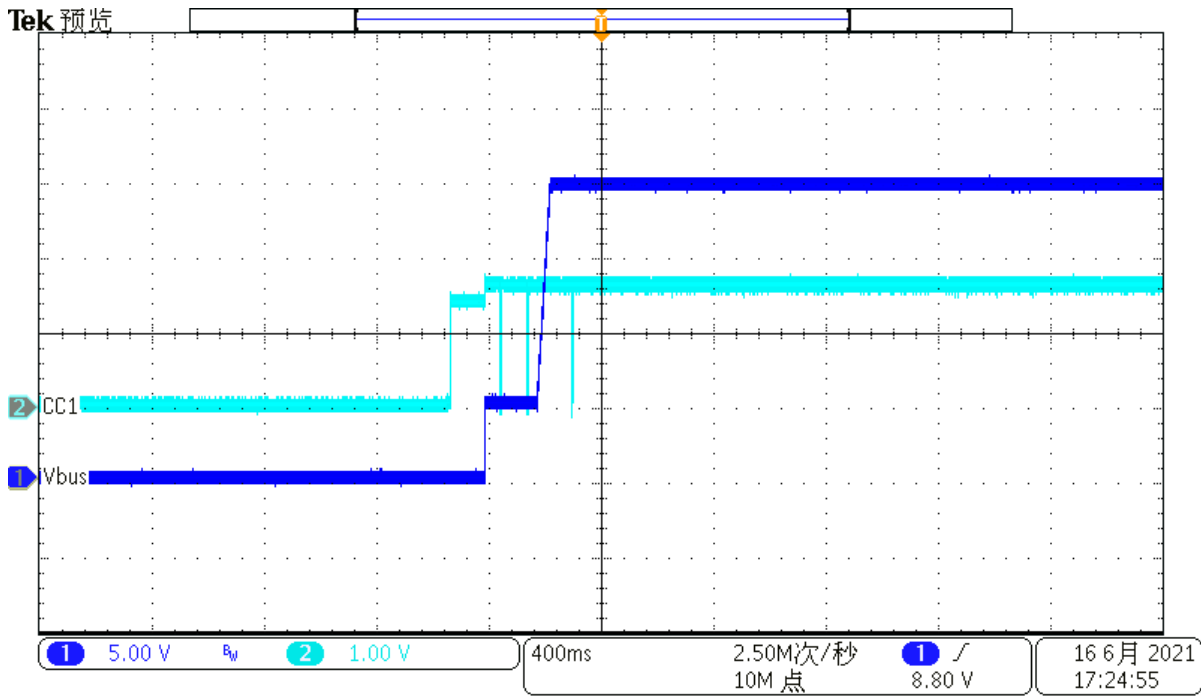


Figure 8. EVB Test Waveform 1

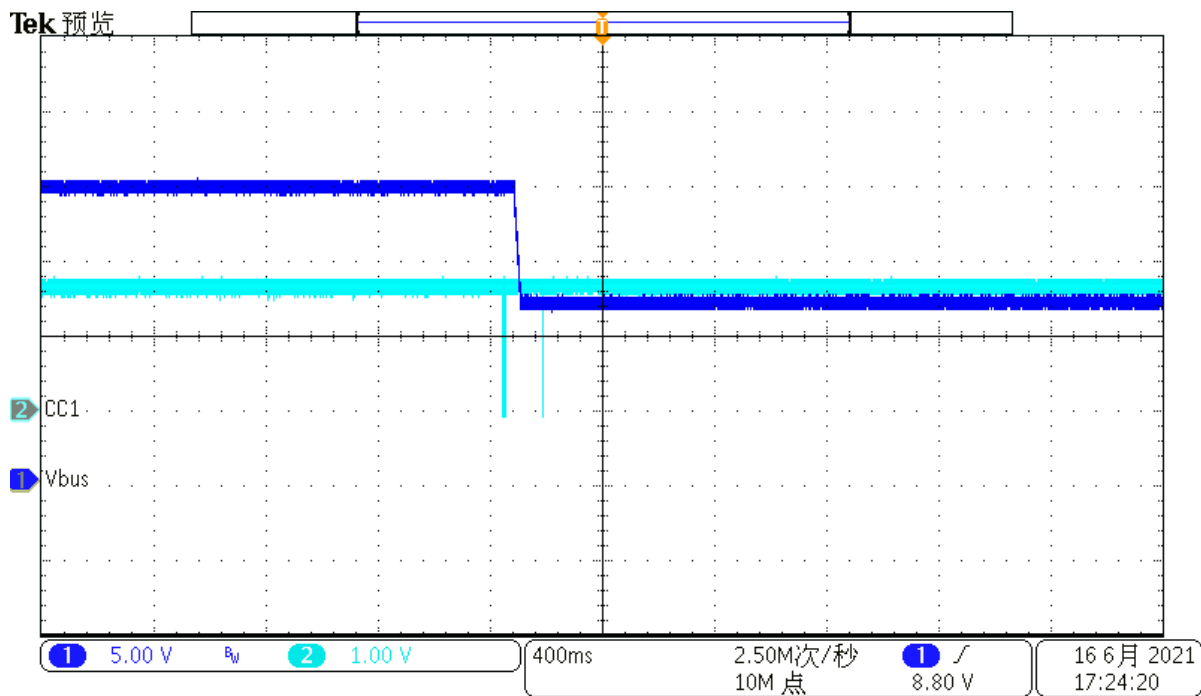
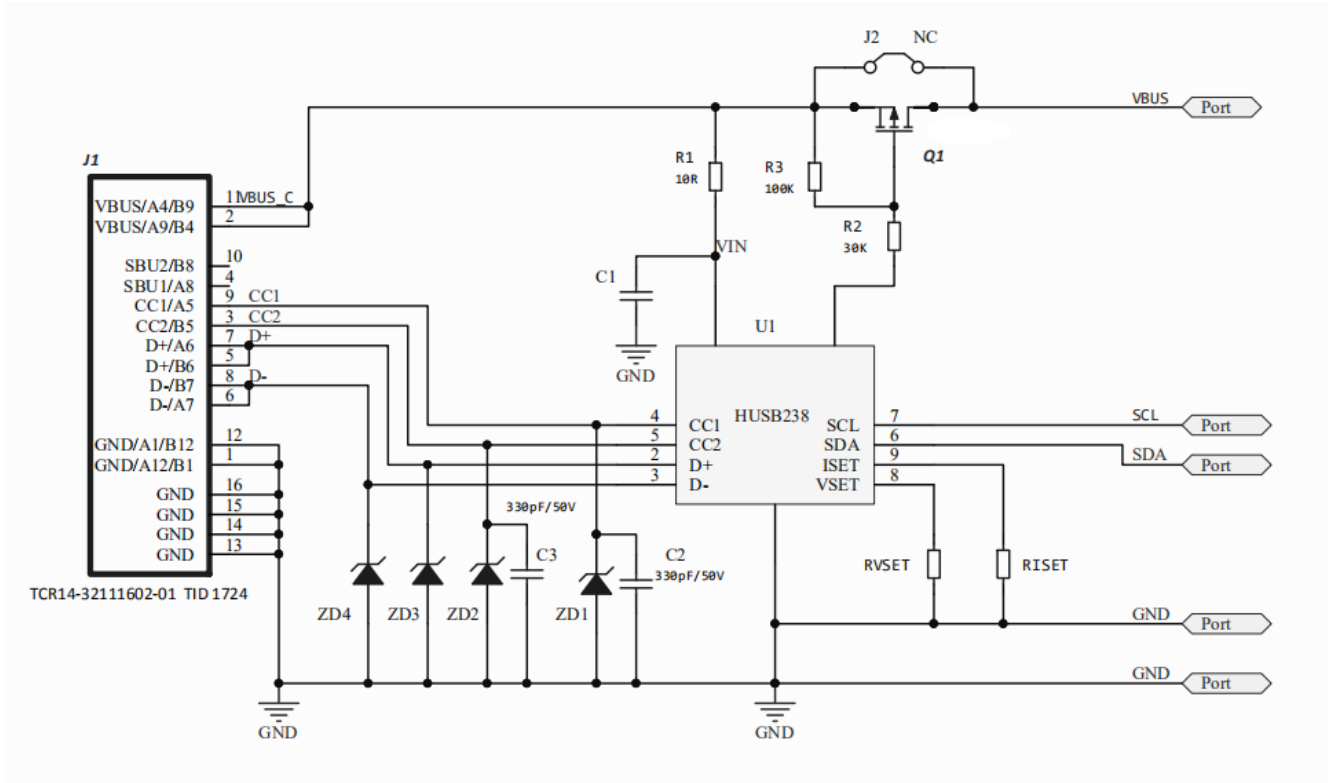


Figure 9. EVB Test Waveform 2

DESIGN DOCUMENTS

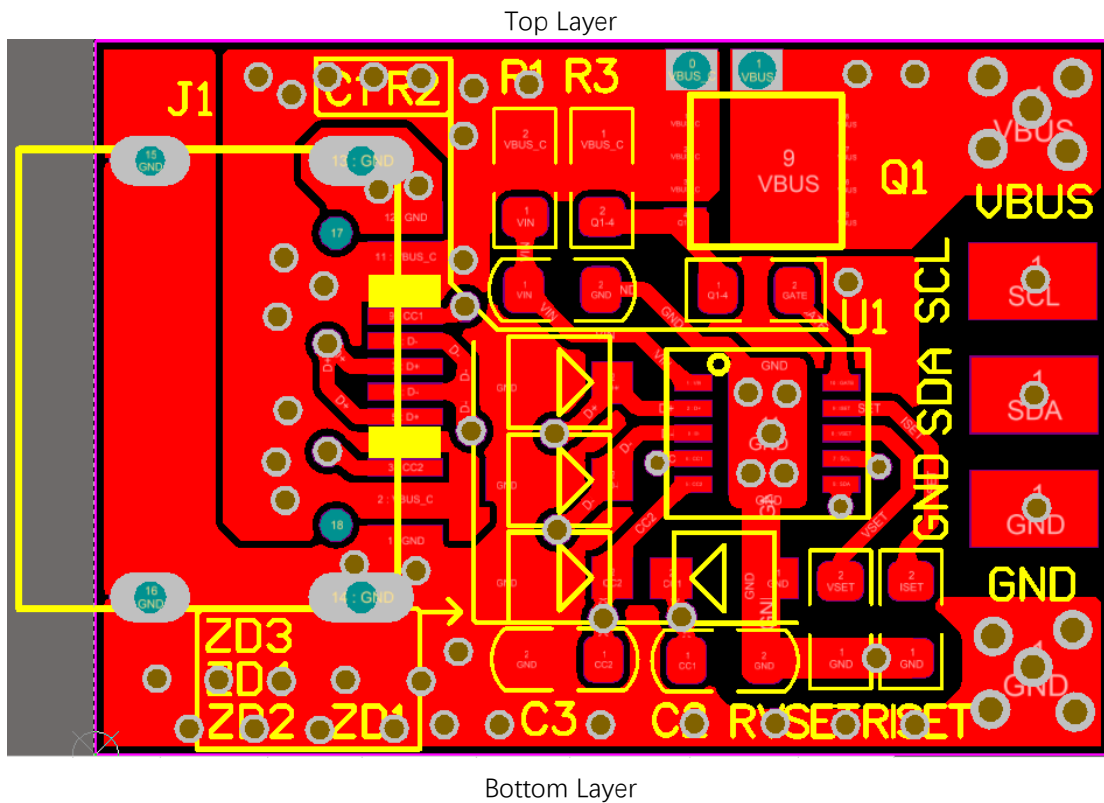
SCHEMATIC

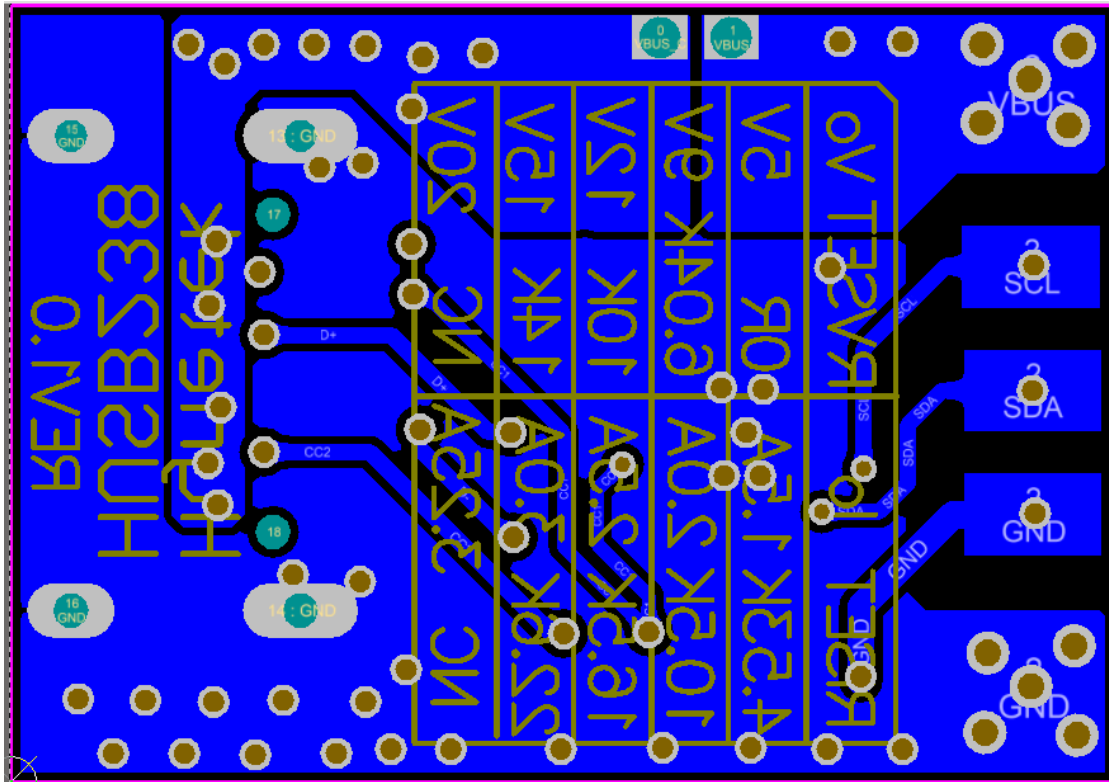


BOM LIST

EVB_HUSB238_002DD BOM							
No.	Material Name	Specification Description			Item	pcs	Remark
Plug-in Part							
1	Resistor	10Ω	0603	5%	R1	1	
2	Resistor	30KΩ	0603	5%	R2	1	
3	Resistor	100KΩ	0603	5%	R3	1	
4	Resistor	NC	0603	1%	RVSET	NC	
5	Resistor	NC	0603	1%	RISET	NC	
6	capacitor	330P50V	X7R	0603	C2.3	2	
7	capacitor	105K50V	X7R	0603	C1	1	
8	TVS diode	NC	TVS	SOD-323	ZD1.2.3.4	NC	
9	MOSFET	AD30P47D3	P-MOS	DFN3*3	Q1	1	
10	IC	HUSB238_002DD	DFN-10L		U1	1	
11	Jumper	NC			J2	NC	
12	Connector	USB3.1 Type-C Receptacle	16PF	SMT	J1	1	

PCB LAYOUT





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